

SCCS060 - August 1994 - Revised March 2000

Features

- FCT-E speed at 3.8 ns
- · Power-off disable outputs permits live insertion
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of -40°C to +85°C
- $V_{CC} = 5V \pm 10\%$

CY74FCT16646T Features:

- · 64 mA sink current, 32 mA source current
- Typical V_{OLP} (ground bounce) <1.0V at V_{CC} = 5V, T_A = 25°C

CY74FCT162646T Features:

- · Balanced 24 mA output drivers
- · Reduced system switching noise
- Typical V_{OLP} (ground bounce) <0.6V at V_{CC} = 5V, T_A = 25°C

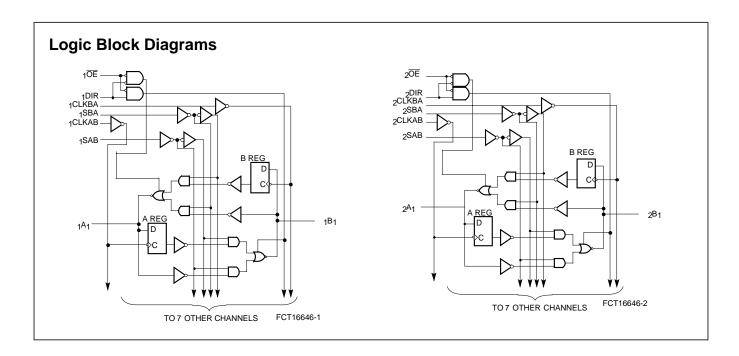
16-Bit Registered Transceivers

Functional Description

CY74FCT16646T and CY74FCT162646T transceivers are three-state, D-type registers, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes to a HIGH logic level. Output Enable (OE) and direction pins (DIR) are provided to control the transceiver function. In the transceiver mode, data present at the high impedance port may be stored in either the A or B register, or in both. The select controls can multiplex stored and real-time (transparent mode) data. The direction control determines which bus will receive data when the Output Enable (OE) is Active LOW. In the isolation mode (Output Enable (OE) HIGH), A data may be stored in the B register and/or B data may be stored in the A register. The output buffers are designed with a power-off disable feature that allows live insertion of boards.

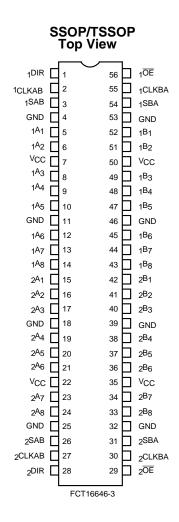
The CY74FCT16646T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162646T has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162646T is ideal for driving transmission lines.





Pin Configuration



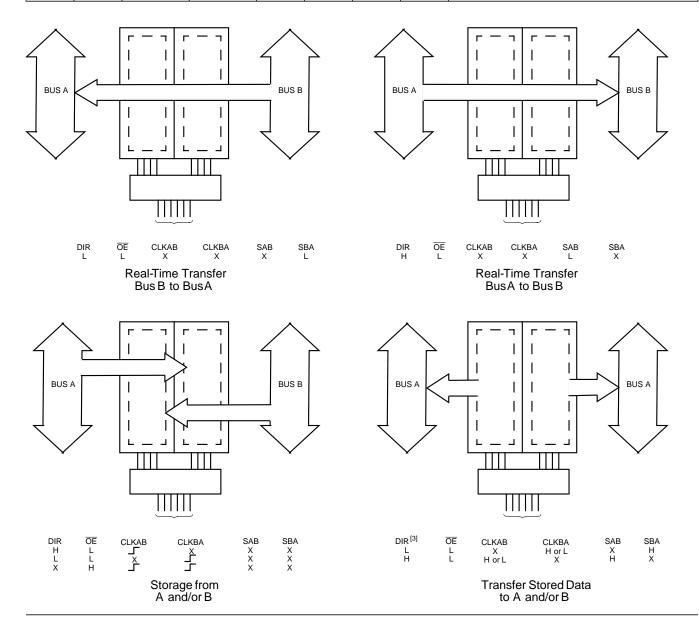
Pin Description

| Pin Names | Description |
|--------------|--|
| А | Data Register A Inputs Data Register B Outputs |
| В | Data Register B Inputs Data Register A Outputs |
| CLKAB, CLKBA | Clock Pulse Inputs |
| SAB, SBA | Output Data Source Select Inputs |
| DIR | Direction |
| ŌĒ | Output Enable (Active LOW) |



Function Table^[1]

| Inputs | | | | | | Data I/O ^[2] | | Function |
|--------|-----|--------|--------|-----|-----|-------------------------|--------|---------------------------|
| OE | DIR | CLKAB | CLKBA | SAB | SBA | Α | В | Tunction |
| Н | Х | H or L | H or L | Х | Х | Input | Input | Isolation |
| Н | X | 工 | | Х | X | | | Store A and B Data |
| L | L | Х | Х | Х | L | Output | Input | Real Time B Data to A Bus |
| L | L | X | H or L | Х | Н | | | Stored B Data to A Bus |
| L | Н | Х | Х | L | Х | Input | Output | Real Time A Data to Bus |
| L | Н | H or L | X | Н | X | | | Stored A Data to B Bus |



- $H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care <math> \Gamma = LOW to-HIGH Transition$ The data output functions may be enabled or disabled by various signals at the \overline{OE} or DIR inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every LOW-to-HIGH transition on the clock inputs. Cannot transfer data to A-bus and B-bus simultaneously.



Maximum Ratings^[4]

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage TemperatureCom'l -55°C to +125°C Ambient Temperature with DC Input Voltage-0.5V to +7.0V DC Output Voltage-0.5V to +7.0V

| DC Output Current | |
|--|--------|
| (Maximum Sink Current/Pin)60 to + | 120 mA |
| Power Dissipation | 1.0W |
| Static Discharge Voltage(per MIL-STD-883, Method 3015) | >2001V |

Operating Range

| Range | Ambient Temperature | V _{CC} |
|------------|------------------------|-----------------|
| Industrial | –40°C to +85°C | 5V ± 10% |

Electrical Characteristics Over the Operating Range

| Parameter | Description | Test Conditions | Min. | Typ. ^[5] | Max. | Unit |
|------------------|---|--|------|----------------------------|------|------|
| V _{IH} | Input HIGH Voltage | | 2.0 | | | V |
| V _{IL} | Input LOW Voltage | | | | 0.8 | V |
| V _H | Input Hysteresis ^[6] | | | 100 | | mV |
| V _{IK} | Input Clamp Diode Voltage | V _{CC} =Min., I _{IN} =-18 mA | | -0.7 | -1.2 | V |
| I _{IH} | Input HIGH Current | V _{CC} =Max., V _I =V _{CC} | | | ±1 | μΑ |
| I _{IL} | Input LOW Current | V _{CC} =Max., V _I =GND | | | ±1 | μΑ |
| l _{OZH} | High Impedance Output Current (Three-State Output pins) | V _{CC} =Max., V _{OUT} =2.7V | | | ±1 | μΑ |
| I _{OZL} | High Impedance Output Current (Three-State Output pins) | V _{CC} =Max., V _{OUT} =0.5V | | | ±1 | μΑ |
| I _{OS} | Short Circuit Current ^[7] | V _{CC} =Max., V _{OUT} =GND | -80 | -140 | -200 | mA |
| Io | Output Drive Current ^[7] | V _{CC} =Max., V _{OUT} =2.5V | -50 | | -180 | mA |
| I _{OFF} | Power-Off Disable | V _{CC} =0V, V _{OUT} ≤4.5V ^[9] | | | ±1 | μΑ |

Output Drive Characteristics for CY74FCT16646T

| Parameter | Description | Test Conditions | Min. | Typ. ^[5] | Max. | Unit |
|-----------------|---------------------|--|------|----------------------------|------|------|
| V _{OH} | Output HIGH Voltage | V _{CC} =Min., I _{OH} =-3 mA | 2.5 | 3.5 | | V |
| | | V _{CC} =Min., I _{OH} =-15 mA | 2.4 | 3.5 | | V |
| | | V _{CC} =Min., I _{OH} =-32 mA | 2.0 | 3.0 | | V |
| V _{OL} | Output LOW Voltage | V _{CC} =Min., I _{OL} =64 mA | | 0.2 | 0.55 | V |

Output Drive Characteristics for CY74FCT162646T

| Parameter | Description | Test Conditions | Min. | Typ. ^[5] | Max. | Unit |
|------------------|------------------------------------|---|------|----------------------------|------|------|
| I _{ODL} | Output LOW Current ^[7] | V_{CC} =5V, V_{IN} = V_{IH} or V_{IL} , V_{OUT} =1.5V | 60 | 115 | 150 | mA |
| I _{ODH} | Output HIGH Current ^[7] | V_{CC} =5V, V_{IN} = V_{IH} or V_{IL} , V_{OUT} =1.5V | -60 | -115 | -150 | mA |
| V _{OH} | Output HIGH Voltage | V _{CC} =Min., I _{OH} =–24 mA | 2.4 | 3.3 | | V |
| V _{OL} | Output LOW Voltage | V _{CC} =Min., I _{OL} =24 mA | | 0.3 | 0.55 | V |

- Stresses greater than those listed under Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation

- of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

 Typical values are at V_{CC}= 5.0V, T_A= +25° C ambient.

 This parameter is specified but not tested.

 Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a birth output may raise the chip temperature well above porceal and thereby cause invalid readings in other parameters. a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametrics tests. In any sequence of parameter
- tests, I_{OS} tests should be performed last. This parameter is measured at characterization but not tested.
- Tested at +25°C.



Capacitance $(T_A = +25^{\circ}C, f = 1.0 \text{ MHz})$

| Symbol | Description ^[8] | Conditions | Тур. | Max. | Unit |
|------------------|----------------------------|----------------------|------|------|------|
| C _{IN} | Input Capacitance | V _{IN} = 0V | 4.5 | 6.0 | pF |
| C _{OUT} | Output Capacitance | V _{OUT} =0V | 5.5 | 8.0 | pF |

Power Supply Characteristics

| Parameter | Description | Test Conditions ^[10] | | Min. | Typ. ^[5] | Max. | Unit |
|------------------|---|--|---|------|----------------------------|----------------------|--------|
| Icc | Quiescent Power Supply Current | V _{CC} =Max. | V _{IN} ≤0.2V V _{IN} ≥V _{CC} -0.2V | _ | 5 | 500 | μА |
| Δl _{CC} | Quiescent Power Supply Current TTL Inputs HIGH | $V_{CC} = Max.$ $V_{IN}=3.4V^{[11]}$ | | _ | 0.5 | 1.5 | mA |
| I _{CCD} | Dynamic Power Supply Current ^[12] | V _{CC} =Max. Outputs Open DIR=OE=GND One-Bit Toggling 50% Duty Cycle | V _{IN} =V _{CC} or V _{IN} =GND | _ | 75 | 120 | μA/MHz |
| I _C | Total Power Supply Current ^[13] | V _{CC} =Max. Outputs Open | V _{IN} =V _{CC} or V _{IN} =GND | _ | 0.8 | 1.7 | mA |
| | | f _o =10 MHz (CLKBA) 50% Duty Cycle DIR=OE=GND One-Bit Toggling f ₁ =5 MHz 50% Duty Cycle | V _{IN} =3.4V or V _{IN} =GND | _ | 1.3 | 3.2 | |
| | | V _{CC} =Max. Outputs Open | V _{IN} =V _{CC} or V _{IN} =GND | _ | 3.8 | 6.5 ^[14] | |
| | | f _o =10 MHz (CLKBA) 50% Duty Cycle DIR=OE=GND Sixteen-Bits Toggling f ₁ =2.5 MHz 50% Duty Cycle | V _{IN} =3.4V or V _{IN} =GND | | 8.3 | 20.0 ^[14] | |

- Notes:
 10. For conditions shown as Max. or Min., use appropriate value specified under Electrical Characteristics for the applicable device type.
 11. Per TTL driven input (V_{IN}=3.4V); all other inputs at V_{CC} or GND.
 12. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
 13. I_C = I_{QUIESCENT} + I_{INPUTS} + I_{DYNAMIC} |
 I_C = I_{CC}+ΔI_{CC}D_HN_T+I_{CCD}(f₀/2 + f₁N₁) |
 I_{CC} = Quiescent Current with CMOS input levels |
 ΔI_{CC} = Power Supply Current for a TTL HIGH input (V_{IN}=3.4V) |
 D_H = Duty Cycle for TTL inputs at D_H |
 I_{CCD} = Dynamic Current caused by an input transition pair (HLH or LHL) |
 f₀ = Clock frequency for registered devices, otherwise zero |
 f₁ = Input signal frequency |
 N₁ = Number of inputs changing at f₁ |
 All currents are in milliamps and all frequencies are in megahertz.
 14. Values for these conditions are examples of the ICC formula. These limits are specified but not tested.



Switching Characteristics Over the Operating Range^[15]

| | | CY74FCT16646AT CY74FCT162646AT | | | | | |
|--------------------------------------|---|--------------------------------|------|------|------|------|--------------------------|
| Parameter | Description | Min. | Max. | Min. | Max. | Unit | Fig. No. ^[16] |
| t _{PLH} t _{PHL} | Propagation Delay Bus to Bus | 1.5 | 9.0 | 1.5 | 6.3 | ns | 1, 2 |
| t _{PZH} t _{PZL} | Output Enable Time DIR or OE to Bus | 1.5 | 14.0 | 1.5 | 9.8 | ns | 1, 7, 8 |
| t _{PHZ} t _{PLZ} | Output Disable Time DIR or OE to Bus | 1.5 | 9.0 | 1.5 | 6.3 | ns | 1, 7, 8 |
| t _{PLH} t _{PHL} | Propagation Delay Clock to Bus | 1.5 | 9.0 | 1.5 | 6.3 | ns | 1, 5 |
| t _{PLH} t _{PHL} | Propagation Delay SBA or SAB to Bus | 1.5 | 11.0 | 1.5 | 7.7 | ns | 1,5 |
| t _{SU} | Set-Up Time HIGH or LOW Bus to Clock | 2.0 | _ | 2.0 | | ns | 4 |
| t _H | Hold Time HIGH or LOW Bus to Clock | 1.5 | _ | 1.5 | _ | ns | 4 |
| t _W | Clock Pulse Width HIGH or LOW | 5.0 | _ | 5.0 | _ | ns | 6 |
| t _{SK(O)} | Output Skew ^[17] | _ | 0.5 | _ | 0.5 | ns | _ |

| | | | | CY74FCT | 16646ET 162646ET | | |
|--------------------------------------|---|------|------|---------|---------------------|------|--------------------------|
| Parameter | Description | Min. | Max. | Min. | Max. | Unit | Fig. No. ^[16] |
| t _{PLH} t _{PHL} | Propagation Delay Bus to Bus | 1.5 | 5.4 | 1.5 | 3.8 | ns | 1, 2 |
| t _{PZH} t _{PZL} | Output Enable Time DIR or OE to Bus | 1.5 | 7.8 | 1.5 | 4.8 | ns | 1, 7, 8 |
| t _{PHZ} t _{PLZ} | Output Disable Time DIR or OE to Bus | 1.5 | 6.3 | 1.5 | 4.0 | ns | 1, 7, 8 |
| t _{PLH} t _{PHL} | Propagation Delay Clock to Bus | 1.5 | 5.7 | 1.5 | 3.8 | ns | 1, 5 |
| t _{PLH} t _{PHL} | Propagation Delay SBA or SAB to Bus | 1.5 | 6.2 | 1.5 | 4.2 | ns | 1,5 |
| t _{SU} | Set-Up Time HIGH or LOW Bus to Clock | 2.0 | _ | 2.0 | _ | ns | 4 |
| t _H | Hold Time HIGH or LOW Bus to Clock | 1.5 | _ | 0.0 | _ | ns | 4 |
| t _W | Clock Pulse Width HIGH or LOW | 5.0 | _ | 3.0 | _ | ns | 6 |
| t _{SK(O)} | Output Skew ^[17] | _ | 0.5 | _ | 0.5 | ns | _ |

^{15.} Minimum limits are specified but not tested on Propagation Delays.
16. See "Parameter Measurement Information" in the General Information section.
17. Skew any two outputs of the same package switching in the same direction. This parameter is ensured by design.



Ordering Information CY74FCT16646

| Speed (ns) | Ordering Code | Package Name | Package Type | Operating Range |
|---------------|------------------------|-----------------|------------------------|--------------------|
| 3.8 | CY74FCT16646ETPVC/PVCT | O56 | 56-Lead (300-Mil) SSOP | Industrial |
| 5.4 | CY74FCT16646CTPVC/PVCT | O56 | 56-Lead (300-Mil) SSOP | Industrial |
| 6.3 | CY74FCT16646ATPVC/PVCT | O56 | 56-Lead (300-Mil) SSOP | Industrial |
| 9.0 | CY74FCT16646TPVC/PVCT | O56 | 56-Lead (300-Mil) SSOP | Industrial |

Ordering Information CY74FCT162646

| Speed (ns) | Ordering Code | Package Name | Package Type | Operating Range |
|---------------|--------------------|-----------------|-------------------------|--------------------|
| 3.8 | 74FCT162646ETPACT | Z56 | 56-Lead (240-Mil) TSSOP | Industrial |
| | CY74FCT162646ETPVC | O56 | 56-Lead (300-Mil) SSOP | |
| | 74FCT162646ETPVCT | O56 | 56-Lead (300-Mil) SSOP | |
| 5.4 | 74FCT162646CTPACT | Z56 | 56-Lead (240-Mil) TSSOP | Industrial |
| | CY74FCT162646CTPVC | O56 | 56-Lead (300-Mil) SSOP | |
| | 74FCT162646CTPVCT | O56 | 56-Lead (300-Mil) SSOP | |
| 6.3 | 74FCT162646ATPACT | Z56 | 56-Lead (240-Mil) TSSOP | Industrial |
| | CY74FCT162646ATPVC | O56 | 56-Lead (300-Mil) SSOP | |
| | 74FCT162646ATPVCT | O56 | 56-Lead (300-Mil) SSOP | |

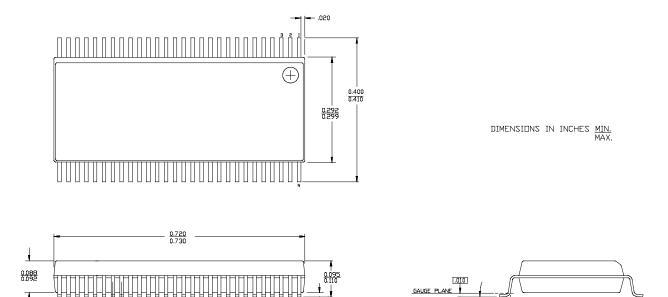


Package Diagrams

0.0335 0.0374

0.0197 BSC

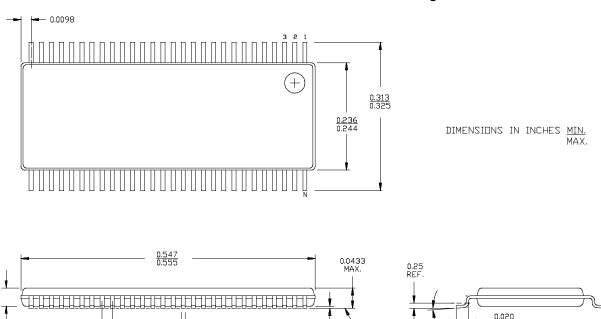
56-Lead Shrunk Small Outline Package O56



56-Lead Thin Shrunk Small Outline Package Z56

0.008

SEATING PLANE



0.002

SEATING PLANE

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